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# MAX3227E 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV IEC ESD PROTECTION

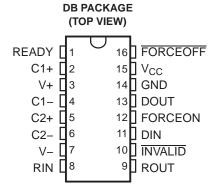
SLLS715A-FEBRUARY 2006-REVISED JUNE 2007

#### **FEATURES**

- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V V<sub>CC</sub> Supply
- Operates at Least 1 Mbit/s
- Low Standby Current . . . 1 μA Typ
- External Capacitors . . . 4 × 0.1 μF
- Accepts 5-V Logic Input With 3.3-V Supply
- Designed to Be Interchangeable With Maxim<sup>™</sup> MAX3227E
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection for RS-232 I/O Pins
  - ±15 kV Human-Body Model
  - ±8 kV IEC61000-4-2, Contact Discharge
  - ±15 kV IEC61000-4-2, Air-Gap Discharge
- Auto-Powerdown Plus Feature Automatically Disables Drivers for Power Savings
- Packaged in Plastic Shrink Small-Outline Package

#### **APPLICATIONS**

- Battery-Powered, Hand-Held, and Portable Equipment
- PDAs and Palmtop PCs
- Notebooks, Sub-Notebooks, and Laptops
- Digital Cameras
- Mobile Phones and Wireless Devices



# **DESCRIPTION/ORDERING INFORMATION**

The MAX3227E consists of one line driver, one line receiver, and a dual charge-pump circuit with ±15-kV IEC ESD protection pin to pin (serial-port connection pins, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. This device operates at data-signaling rates of 1 Mbit/s in normal operating mode and a maximum of 30-V/µs driver output slew rate. This device also features a logic-level output (READY) that asserts when the charge pump is regulating and the device is ready to begin transmitting.

The MAX3227E achieves a 1-µA supply current using the auto-powerdown plus feature. This device automatically enters a low-power powerdown mode when the RS-232 cable is disconnected or the drivers of the connected peripherals are inactive for more than 30 s. They turn on again when they sense a valid transition at any driver or receiver input. Auto-powerdown saves power without changes to the existing BIOS or operating system.

The MAX3227EC is characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C. The MAX3227EI is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

#### ORDERING INFORMATION

T <sub>A</sub>	PACKAGE <sup>(1)(2)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	SSOP – DB	Tube of 80	MAX3227ECDB	MD227EC
0°C to 70°C	220b – DB	Reel of 2000	MAX3227ECDBR	MP227EC
-40°C to 85°C	SSOP – DB	Tube of 80	MAX3227EIDB	MP227EI
-40°C 10 85°C	220b – DB	Reel of 2000	MAX3227EIDBR	WP227EI

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

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# 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm 15$ -kV IEC ESD PROTECTION





# **FUNCTION TABLE**(1)

	INPUT CO	NDITIONS			OUTPUT S	STATES		
FORCEON	FORCEOFF	RECEIVER OR DRIVER EDGE WITHIN 30 s	VALID RS-232 LEVEL PRESENT AT RECEIVER	DRIVER	RECEIVER	ĪNVALID	READY	OPERATING MODE
			Auto-	Powerdow	n Plus Condit	ions		
Н	Н	NO	NO	Active	Active	L	Н	Normal operation, auto-powerdown plus disabled
Н	Н	NO	YES	Active	Active	Н	Н	Normal operation, auto-powerdown plus disabled
L	Н	YES	NO	Active	Active	L	Н	Normal operation, auto-powerdown plus enabled
L	Н	YES	YES	Active	Active	Н	Н	Normal operation, auto-powerdown plus enabled
L	Н	NO	NO	Z	Active	L	L	Powerdown, auto-powerdown plus enabled
L	Н	NO	YES	Z	Active	Н	L	Powerdown, auto-powerdown plus enabled
Х	L	Х	NO	Z	Active	L	L	Manual powerdown
X	L	X	YES	Z	Active	Н	L	Manual powerdown
			Au	to-Powerd	own Conditio	ns		
INVALID	INVALID	Х	NO	Z	Active	L	L	Powerdown, auto-powerdown enabled
INVALID	INVALID	X	YES	Active	Active	Н	Н	Normal operation, auto-powerdown enabled

<sup>(1)</sup> H = high level, L = low level, X = irrelevant, Z = high impedance

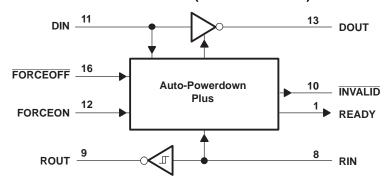
# MAX3227E 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm$ 15-kV IEC ESD PROTECTION

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#### **TERMINAL FUNCTIONS**

TERMINA	<b>AL</b>	DESCRIPTION
NAME	NO.	DESCRIPTION
C1+	2	Positive terminal of voltage-doubler charge-pump capacitor
C1-	4	Negative terminal of voltage-doubler charge-pump capacitor
C2+	5	Positive terminal of inverting charge-pump capacitor
C2-	6	Negative terminal of inverting charge-pump capacitor
DIN	11	CMOS driver input
DOUT 13 RS-232 driver output		
FORCEOFF 16 Force-off input, active low. Drive low to shut down drivers, receivers, and charge pump. This overrides auto-sand FORCEON (see Function Table).		
FORCEON	12	Force-on input, active high. Drive high to override powerdown, keeping drivers and receivers on (FORCEOFF must be high) (see Function Table).
GND	14	Ground
INVALID	10	Valid signal detector output, active low. A logic high indicates that a valid RS-232 level is present on a receiver input.
READY	1	Ready to transmit output, active high. READY is enabled high when V- goes below -3.5 V and the device is ready to transmit.
RIN	8	RS-232 receiver input
ROUT	9	CMOS receiver output
V+	3	$+2 \times V_{CC}$ generated by the charge pump
V-	7	$-2 \times V_{CC}$ generated by the charge pump
V <sub>CC</sub>	15	3-V to 5.5-V single-supply voltage

# **LOGIC DIAGRAM (POSITIVE LOGIC)**



### **MAX3227E**

# 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV IEC ESD PROTECTION



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## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range <sup>(2)</sup>		-0.3	6	V
V+	Positive output supply voltage range (2)		-0.3	7	V
V-	egative output supply voltage range <sup>(2)</sup>		0.3	-7	V
V+ - V-	Supply voltage difference <sup>(2)</sup>	Š			V
VI	Input voltage range	Driver (FORCEOFF, FORCEON)	-0.3	6	V
	input voltage range	Receiver	-25	25	V
V	Output valtage range	Driver	-13.2	13.2	\ \ \
Vo	Output voltage range	Receiver (INVALID, READY)	-0.3	$V_{CC} + 0.3$	V
	Short-circuit duration	DOUT to GND		Unlimited	
$\theta_{JA}$	Package thermal impedance (3)			82	°C/W
	Lead temperature 1,6 mm (1/16 in) from case	se for 10 s		260	°C
T <sub>stg</sub>	Storage temperature range		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# Recommended Operating Conditions<sup>(1)</sup>

See Figure 5

				MIN	NOM	MAX	UNIT
	Supply voltage		V <sub>CC</sub> = 3.3 V	3	3.3	3.6	V
	Supply voltage  Driver and control high-level input voltage  DIN, FORCEOFF, FORCEON  Driver and control low-level input voltage  DIN, FORCEOFF, FORCEON  Receiver input voltage  Operating free-air temperature	$V_{CC} = 5 V$	4.5	5	5.5	V	
V	Driver and control high-level input voltage	DIN FORCEOFF FORCEON	$V_{CC} = 3.3 \text{ V}$	2		5.5	V
V <sub>IH</sub>		DIN, FORCEOFF, FORCEON	$V_{CC} = 5 V$	2.4		5.5	V
$V_{IL}$	Driver and control low-level input voltage	DIN, FORCEOFF, FORCEON		0		8.0	V
$V_{I}$	Receiver input voltage			-25		25	V
т.	Operating free air temperature		MAX3227EC	0		70	°C
IA	Operating nee-all temperature		MAX3227EI	-40		85	

<sup>(1)</sup> Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V  $\pm$  0.5 V.

#### Electrical Characteristics(1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)

	PARA	METER	TEST CONDITIONS	MIN	TYP <sup>(2)</sup>	MAX	UNIT
I <sub>I</sub>	Input leakage current	FORCEOFF, FORCEON			±0.01	±1	μA
1		Auto-powerdown plus disabled	No load, FORCEOFF and FORCEON at V <sub>CC</sub>		0.3	2	2 mA
	Supply current	Powered off	No load, FORCEOFF at GND		1	10	
Icc	(T <sub>A</sub> = 25°C)	Auto-powerdown plus enabled	No load, FORCEOFF at V <sub>CC</sub> , FORCEON at GND, All RIN are open or grounded		1	10	μΑ

<sup>(1)</sup> Test conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC}$  = 3.3 V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at  $V_{CC}$  = 5 V  $\pm$  0.5 V. (2) All typical values are at  $V_{CC}$  = 3.3 V or  $V_{CC}$  = 5 V, and  $T_A$  = 25°C.

All voltages are with respect to network GND.

<sup>(3)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

# 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIV WITH ±15-kV IEC ESD PROTECTION

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#### **DRIVER SECTION**

# Electrical Characteristics(1)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1 and Figure 2)

	PARAMETER	TEST C	ONDITIONS		MIN	TYP <sup>(2)</sup>	MAX	UNIT
$V_{OH}$	High-level output voltage	DOUT at $R_L = 3 \text{ k}\Omega$ to GND,	DIN = GND		5	5.4		V
$V_{OL}$	Low-level output voltage	DOUT at $R_L = 3 \text{ k}\Omega$ to GND,	DIN = V <sub>CC</sub>		-5	-5.4		V
I <sub>IH</sub>	High-level input current	$V_I = V_{CC}$				±0.01	±1	μΑ
I <sub>IL</sub>	Low-level input current	V <sub>I</sub> at GND				±0.01	±1	μΑ
	Short-circuit output current (3)	V <sub>CC</sub> = 3.6 V,	V <sub>O</sub> = 0 V			±35	±60	A
los	Short-circuit output current	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0 V			±35	±60	mA
r <sub>o</sub>	Output resistance	$V_{CC}$ , V+, and V- = 0 V,	V <sub>O</sub> = ±2 V		300	10M		Ω
I <sub>off</sub>	Output leakage current	FORCEOFF = GND,	$V_0 = \pm 12 V$ ,	V <sub>CC</sub> = 0 to 5.5 V			±25	μΑ

# Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1 and Figure 2)

	PARAMETER	TI	EST CONDITIONS		MIN	TYP <sup>(2)</sup>	MAX	UNIT
		C <sub>L</sub> = 1000 pF, One DIN switching,	$R_L = 3 \text{ k}\Omega$ , See Figure 1		250			
	Maximum data rate	C <sub>L</sub> = 1000 pF, V <sub>CC</sub> = 4.5 V,	$R_L = 3 \text{ k}\Omega$ , See Figure 1	One DIN switching,	1000			kbit/s
		C <sub>L</sub> = 250 pF, V <sub>CC</sub> = 3 V,	$R_L = 3 \text{ k}\Omega,$ See Figure 1	One DIN switching,	1000			
t <sub>sk(p)</sub>	Pulse skew <sup>(3)</sup>	$C_L = 150 \text{ pF to } 2500 \text{ pF},$	$R_L = 3 \text{ k}\Omega \text{ to } 7 \text{ k}\Omega,$	See Figure 2		25		ns
SR(tr)	Slew rate, transition region	$V_{CC} = 3.3 \text{ V},$ $C_L = 150 \text{ pF to } 1000 \text{ pF},$	$R_L = 3 \text{ k}\Omega \text{ to } 7 \text{ k}\Omega,$ See Figure 1		24		150	V/µs

<sup>(1)</sup> Test conditions are C1–C4 = 0.1  $\mu$ F at V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at V<sub>CC</sub> = 5 V  $\pm$  0.5 V. (2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C. (3) Pulse skew is defined as  $|t_{PLH}-t_{PHL}|$  of each channel of the same device.

#### **ESD Protection**

TERMIN	IAL	TEST CONDITIONS	TYP	UNIT
NAME	NO.	TEST CONDITIONS	ITP	UNII
		Human-Body Model	±15	
DOUT	13	Contact Discharge (IEC61000-4-2)	±8	kV
		Air-Gap Discharge (IEC61000-4-2)	±15	

 <sup>(1)</sup> Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.
 (2) All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.
 (3) Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

# **MAX3227E**

# 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV IEC ESD PROTECTION



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#### RECEIVER SECTION

#### Electrical Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 3)

	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(2)</sup>	MAX	UNIT
$V_{OH}$	High-level output voltage	$I_{OH} = -1 \text{ mA}$	V <sub>CC</sub> - 0.6	V <sub>CC</sub> - 0.1		V
$V_{OL}$	Low-level output voltage	I <sub>OL</sub> = 1.6 mA			0.4	V
\/	Desitive going input threshold voltage	V <sub>CC</sub> = 3.3 V		1.5	2.4	V
V <sub>IT+</sub>	Positive-going input threshold voltage	V <sub>CC</sub> = 5 V		1.8	2.4	V
V	Negative going input threshold voltage	V <sub>CC</sub> = 3.3 V	0.6	1.2		V
V <sub>IT</sub>	Negative-going input threshold voltage	V <sub>CC</sub> = 5 V	0.8	1.5		V
$V_{\text{hys}}$	Input hysteresis (V <sub>IT+</sub> - V <sub>IT-</sub> )			0.5		V
I <sub>off</sub>	Output leakage current			±0.05	±10	μΑ
r <sub>i</sub>	Input resistance	$V_1 = \pm 3 \text{ V to } \pm 25 \text{ V}$	3	5	7	kΩ

<sup>(1)</sup> Test conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC}$  = 3.3 V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at  $V_{CC}$  = 5 V  $\pm$  0.5 V. (2) All typical values are at  $V_{CC}$  = 3.3 V or  $V_{CC}$  = 5 V, and  $T_A$  = 25°C.

## Switching Characteristics<sup>(1)</sup>

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	TYP <sup>(2)</sup>	UNIT
t <sub>PLH</sub>	Propagation delay time, low- to high-level output	C <sub>L</sub> = 150 pF, See Figure 3	150	ns
t <sub>PHL</sub>	Propagation delay time, high- to low-level output	C <sub>L</sub> = 150 pF, See Figure 3	150	ns
t <sub>sk(p)</sub>	Pulse skew <sup>(3)</sup>	See Figure 3	50	ns

<sup>(1)</sup> Test conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC}$  = 3.3  $V \pm 0.3$  V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at  $V_{CC}$  = 5  $V \pm 0.5$  V. (2) All typical values are at  $V_{CC}$  = 3.3 V or  $V_{CC}$  = 5 V, and  $T_A$  = 25°C. (3) Pulse skew is defined as  $|t_{PLH}|$  of each channel of the same device.

#### **ESD Protection**

TERMINAL TEST CONDITIONS		TEST COMPITIONS	TVD	LINUT
NAME	NO.	TEST CONDITIONS	TYP	UNIT
		Human-Body Model	±15	
RIN	8	Contact Discharge (IEC61000-4-2)	±8	kV
		Air-Gap Discharge (IEC61000-4-2)	±15	

# 3-V TO 5.5-V SINGLE-CHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV IEC ESD PROTECTION

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### **AUTO-POWERDOWN SECTION**

# **Electrical Characteristics**

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 4)

	PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
V <sub>T+(valid)</sub>	Receiver input threshold for INVALID high-level output voltage	FORCEON = GND, FORCEOFF = V <sub>CC</sub>		2.7	V
V <sub>T-(valid)</sub>	Receiver input threshold for INVALID high-level output voltage	FORCEON = GND, FORCEOFF = V <sub>CC</sub>	-2.7		V
V <sub>T(invalid)</sub>	Receiver input threshold for INVALID low-level output voltage	FORCEON = GND, FORCEOFF = V <sub>CC</sub>	-0.3	0.3	V
V <sub>OH</sub>	INVALID, READY output voltage high	I <sub>OH</sub> = -1 mA, FORCEON = GND, FORCEOFF = V <sub>CC</sub>	V <sub>CC</sub> - 0.6		V
V <sub>OL</sub>	INVALID, READY output voltage low	I <sub>OL</sub> = 1.6 mA, FORCEON = GND, FORCEOFF = V <sub>CC</sub>		0.4	V

### **Switching Characteristics**

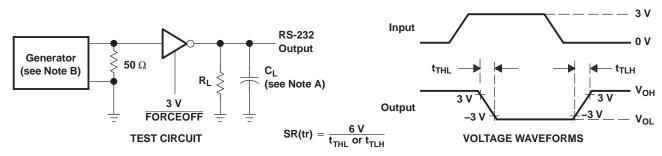
over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 4)

	PARAMETER		MIN	TYP <sup>(1)</sup>	MAX	UNIT
$t_{INVH}$	Propagation delay time, low- to high-level output			1		μs
t <sub>INVL</sub>	Propagation delay time, high- to low-level output		30		μs	
t <sub>WU</sub>	Supply enable time			100		μs
t <sub>AUTOPRDN</sub>	Driver or receiver edge to driver's shutdown	V <sub>CC</sub> = 5 V	15	30	60	s

<sup>(1)</sup> All typical values are at  $V_{CC}$  = 3.3 V or  $V_{CC}$  = 5 V, and  $T_A$  = 25°C.



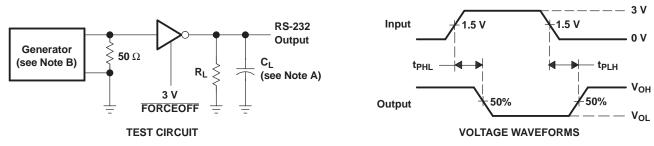
#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_{O}$  = 50  $\Omega$ , 50% duty cycle,  $t_{f}$   $\leq$  10 ns,  $t_{f}$   $\leq$  10 n

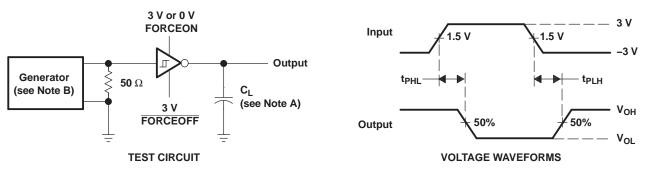
Figure 1. Driver Slew Rate



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_{O}$  = 50  $\Omega$ , 50% duty cycle,  $t_{f}$   $\leq$  10 ns,  $t_{f}$   $\leq$  10 ns.

Figure 2. Driver Pulse Skew



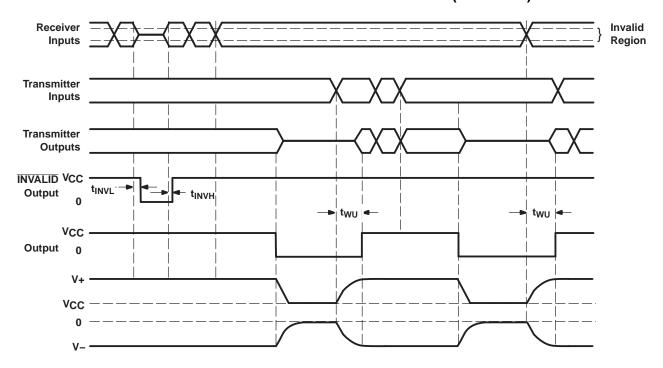
NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

B. The pulse generator has the following characteristics:  $Z_0 = 50 \Omega$ , 50% duty cycle,  $t_r \le 10$  ns.  $t_f \le 10$  ns.

Figure 3. Receiver Propagation Delay Times

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### PARAMETER MEASUREMENT INFORMATION (continued)



#### **VOLTAGE WAVEFORMS**

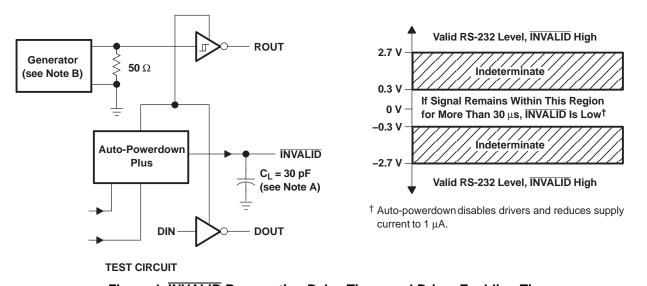
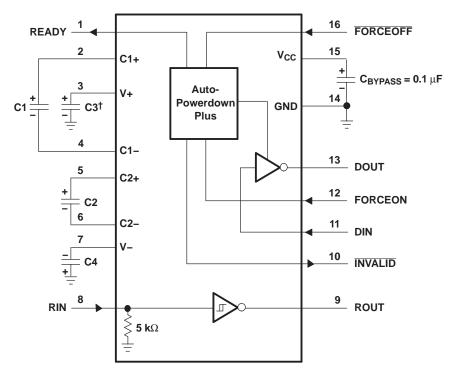


Figure 4. INVALID Propagation Delay Times and Driver Enabling Time



### **APPLICATION INFORMATION**



 $<sup>^{\</sup>dagger}$  C3 can be connected to  $V_{CC}$  or GND.

- NOTES: A. Resistor values shown are nominal.
  - B. Nonpolarized ceramic capacitors are acceptable. If polarized tantalum or electrolytic capacitors are used, they should be connected as shown.

#### **V<sub>CC</sub> vs CAPACITOR VALUES**

V <sub>CC</sub>	C1	C2, C3, and C4
$\begin{array}{c} 3.3 \text{ V} \pm 0.3 \text{ V} \\ 5 \text{ V} \pm 0.5 \text{ V} \\ 3 \text{ V to 5.5 V} \end{array}$	0.1 μF 0.047 μF 0.1 μF	0.1 μF 0.33 μF 0.47 μF

Figure 5. Typical Operating Circuit and Capacitor Values

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#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
MAX3227ECDB	ACTIVE	SSOP	DB	16	80	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	MP227EC	Samples
MAX3227ECDBR	ACTIVE	SSOP	DB	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	MP227EC	Samples
MAX3227EIDB	ACTIVE	SSOP	DB	16	80	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MP227EI	Samples
MAX3227EIDBG4	ACTIVE	SSOP	DB	16	80	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MP227EI	Samples
MAX3227EIDBR	ACTIVE	SSOP	DB	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MP227EI	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



# **PACKAGE OPTION ADDENDUM**

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# TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

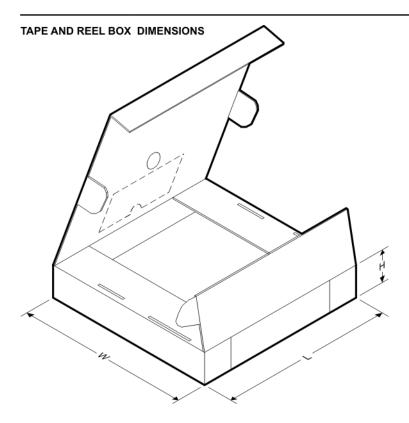
### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
MAX3227ECDBR	SSOP	DB	16	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
MAX3227EIDBR	SSOP	DB	16	2000	330.0	16.4	8.35	6.6	2.5	12.0	16.0	Q1

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
MAX3227ECDBR	SSOP	DB	16	2000	853.0	449.0	35.0
MAX3227EIDBR	SSOP	DB	16	2000	853.0	449.0	35.0

# DB (R-PDSO-G\*\*)

# PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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